

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Viorel Olariu	02/20/2008
RECEIVING PARTY DATA	
Name:	Weyerhaeuser Company
Street Address:	33663 Weyerhaeuser Way S
Internal Address:	Intellectual Property CH 1J27
City:	Federal Way
State/Country:	WASHINGTON
Postal Code:	98003
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	11964541
CORRESPONDENCE DATA	
Fax Number:	(253)924-3253
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Phone:	2539242063
Email:	casey.leichter@weyerhaeuser.com
Correspondent Name:	Weyerhaeuser Company
Address Line 1:	PO Box 9777
Address Line 2:	Intellectual Property CH 1J27
Address Line 4:	Federal Way, WASHINGTON 98063-9777
ATTORNEY DOCKET NUMBER:	26397
NAME OF SUBMITTER:	Casey Leichter
Total Attachments: 2 source=26397_Assignment#page1.tif source=26397_Assignment#page2.tif	

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PATENT

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REEL: 020578 FRAME: 0454

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A S S I G N M E N T

WHEREAS, I, Viorel Olariu, a citizen of Romania, am an inventor of certain new and useful improvements entitled "Printed organic logic circuits using an organic semiconductor as a resistive load device," for which I have executed an application for Letters Patent of the United States of America, filed December 26, 2007, as Serial No. 11/964,541.

WHEREAS, WEYERHAEUSER COMPANY, a Washington corporation, having its principal place of business at Federal Way, King County, Washington (hereinafter referred to as the ASSIGNEE), wishes to obtain the entire right and interest in the invention;

NOW, THEREFORE, in consideration of good and valuable consideration, the receipt of which is acknowledged, I the inventor have sold, assigned, transferred and set over, and by these presents do sell, assign, transfer and set over, to the ASSIGNEE, its successors, legal representatives and assigns, the entire right, title and interest in, to and under the invention, and the application and all divisions and continuations thereof, and all Letters Patent of the United States of America which may be granted thereon and all reissues and extensions thereof, and all applications for Letters Patent which may hereafter be filed for improvements in any country or countries foreign to the United States of America, and all Letters Patent which may be granted for improvements in any country or countries foreign to the United States of America and all extensions and reissues thereof; and I authorize and request the Commissioner of Patents and Trademarks of the United States of America and any Official of any country or countries foreign to the United States of America, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for this invention to the ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND I covenant that I have full right to convey the entire interest herein assigned and that I have not executed, and will not execute, any agreement in conflict herewith.

AND I further covenant and agree that I will communicate to the ASSIGNEE, its successors, legal representatives and assigns, any facts known to me respecting improvements, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid the ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for improvements in all countries.

IN TESTIMONY WHEREOF, I set my signature this

(1) 20 day of February, 2008.

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